

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT8381418

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
JIANFENG LIU	01/05/2024
HEPING XIE	01/05/2024
CHAO MA	01/05/2024
FUJUN XUE	01/05/2024
JINGJING DAI	01/05/2024
JIANXIONG YANG	01/05/2024
LU WANG	01/05/2024
ZHIJUN WU	01/05/2024
XIANGCHAO SHI	01/05/2024
HOUQUAN ZHANG	01/05/2024
YINGHUI MA	01/05/2024
TAO MENG	01/05/2024
DEFU ZHU	01/05/2024
SHAOQI KONG	01/05/2024

RECEIVING PARTY DATA

Name:	SICHUAN UNIVERSITY
Street Address:	NO. 24, SOUTH SECTION 1, YIHUAN ROAD, CHENGDU, SICHUAN
City:	CHENGDU
State/Country:	CHINA

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	18413048

CORRESPONDENCE DATA**Fax Number:**

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 7024625973**Email:** in@bayramoglu-legal.com**Correspondent Name:** GOKALP BAYRAMOGLU**Address Line 1:** 1540 WEST WARM SPRINGS RD., SUITE 100 HENDERSON**PATENT**

Address Line 2: SUITE 100
Address Line 4: HENDERSON, NEVADA 89014

ATTORNEY DOCKET NUMBER: GBZJCD-LM005

NAME OF SUBMITTER: GOKALP BAYRAMOGLU

SIGNATURE: /GOKALP BAYRAMOGLU/

DATE SIGNED: 01/16/2024

Total Attachments: 3

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ASSIGNMENT

- | | | |
|---|-------------------|--------------------|
| <i>(1-14) Insert Name(s) of Inventor(s)</i> | (1) Jianfeng LIU | (2) Heping XIE |
| | (3) Chao MA | (4) Fujun XUE |
| | (5) Jingjing DAI | (6) Jianxiong YANG |
| | (7) Lu WANG | (8) Zhijun WU |
| | (9) Xiangchao SHI | (10) Houquan ZHANG |
| | (11) Yinghui MA | (12) Tao MENG |
| | (13) Defu ZHU | (14) Shaoqi KONG |
-

For good and valuable consideration receipt of which is hereby acknowledged, the undersigned agree(s) to assign, and hereby do(es) assign, transfer and set over to:

- | | | |
|--|---------------|---|
| <i>(15) name of Assignee</i> | <i>Insert</i> | (15) SICHUAN UNIVERSITY |
| <i>(16) Insert state of incorporation of Assignee</i> | | (16) China |
| <i>(17) Insert address of Assignee</i> | | (17) NO. 24, SOUTH SECTION 1, YIHUAN ROAD, CHENGDU, SICHUAN CHENGDU, CHINA

(hereinafter designated as the Assignee) the entire right, title, interest, and patent applications and patents within the United States, including divisions, reissues, continuations and all other extensions, rights and priorities in the invention known as and subject matter contained in |
| <i>(18) Insert Identification of Invention, such as Title, Case Number or Foreign Application Number</i> | | (18) Shear Testing System of Thermo-Seepage-Mechanical Field and Engineering Disturbance Coupling Under Deep and Complex Condition |
| <i>(19) Insert Date of Filing of Application</i> | | (19) <u>Application is attached hereto.</u> |

1) The undersigned agree(s) to execute all papers necessary in connection with the application and any continuing or division applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

2) The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation or division thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

3) The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

4) The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

5) The undersigned hereby authorize(s) and request(s) the Commissioner for Patents and the duly constituted authorities of foreign countries to issue any and all Letters Patents resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, its successors and assigns, as Assignee of the entire right, title and interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed and will not execute, any agreement in conflict herewith.

6) *The undersigned hereby grant(s)*

the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Date 2024.01.05

Jianfeng Liu
Jianfeng LIU

Date 2024.01.05

Heping XIE
Heping XIE

Date 2024.1.5

Chao Ma
Chao MA

Date 2024.01.05

Fujun XUE
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Date 2024.01.05

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Jianxiong YANG
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Shaogui KONG
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